

Data sheet acquired from Harris Semiconductor SCHS027C – Revised February 2004

CMOS Counter/Dividers

High-Voltage Types (20-Volt Rating) CD4017B—Decade Counter with

10 Decoded Outputs

CD4022B-Octal Counter with

8 Decoded Outputs

■ CD4017B and CD4022B are 5stage and 4-stage Johnson counters having 10 and 8 decoded outputs, respectively. Inputs include a CLOCK, a RESET, and a CLOCK INHIBIT signal. Schmitt trigger action in the CLOCK input circuit provides pulse shaping that allows unlimited clock input pulse rise and fall times.

These counters are advanced one count at the positive clock signal transition if the CLOCK INHIBIT signal is low. Counter advancement via the clock line is inhibited when the CLOCK INHIBIT signal is high. A high RESET signal clears the counter to its zero count. Use of the Johnson counter configuration permits high-speed operation, 2-input decode-gating and spike-free decoded outputs. Anti-lock gating is provided, thus assuring proper counting sequence. The decoded outputs are normally low and go high only at their respective decoded time slot. Each decoded output remains high for one full clock cycle. A CARRY-OUT signal completes one cycle every 10 clock input cycles in the CD4017B or every 8 clock input cycles in the CD4022B and is used to ripple-clock the succeeding device in a multi-device counting chain.

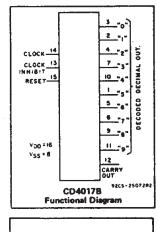
Features:

- Fully static operation
- Medium-speed operation . . .
- 10 MHz (typ.) at V_{DD} = 10 V
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13A, "Standard Specifications for Description of 'B' Series CMOS Devices"

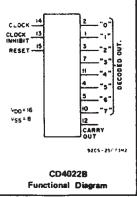
Applications:

- Decade counter/decimal decode display (CD4017B)
- Binary counter/decoder
- **Frequency division**
- Counter control/timers
- . **Divide-by-N counting**
- For further application information, see ICAN-6166 "COS/MOS MSI Counter and Register Design and **Applications**"

The CD4017B and CD4022B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic package (E suffix), 16-lead small-outline packages (NSR suffix), and 16-lead thin shrink small-outline packages (PW and PWR suffixes). The CD4017B types also are supplied in 16-lead small-outline packages (M and M96 suffixes).



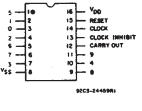
CD4017B, CD4022B Types



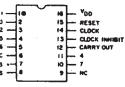
RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTICS	V _{DD}	LIN	UNITS	
	(V)	Min.	Max.	
Supply-Voltage Range (For T _A = Full Package- Temperature Range)		3	18	v
Clock Input Frequency, f _{CL}	5 10 15	1 1	2.5 5 5.5	MHz
Clock Pulse Width, t _W	5 10 15	200 90 60		. ns
Clock Rise & Fall Time, t _{rCL} , t _{fCL}	5 10 15	UNLIN	NITED*	·*.
Clock Inhibit Setup Time, t _s	5 10 15	230 100 70	-	ns
Reset Pulse Width, t _{RW}	5 10 15	260 110 60		ns
Reset Removal Time, t _{rem}	5 10 15	400 280 150		ns



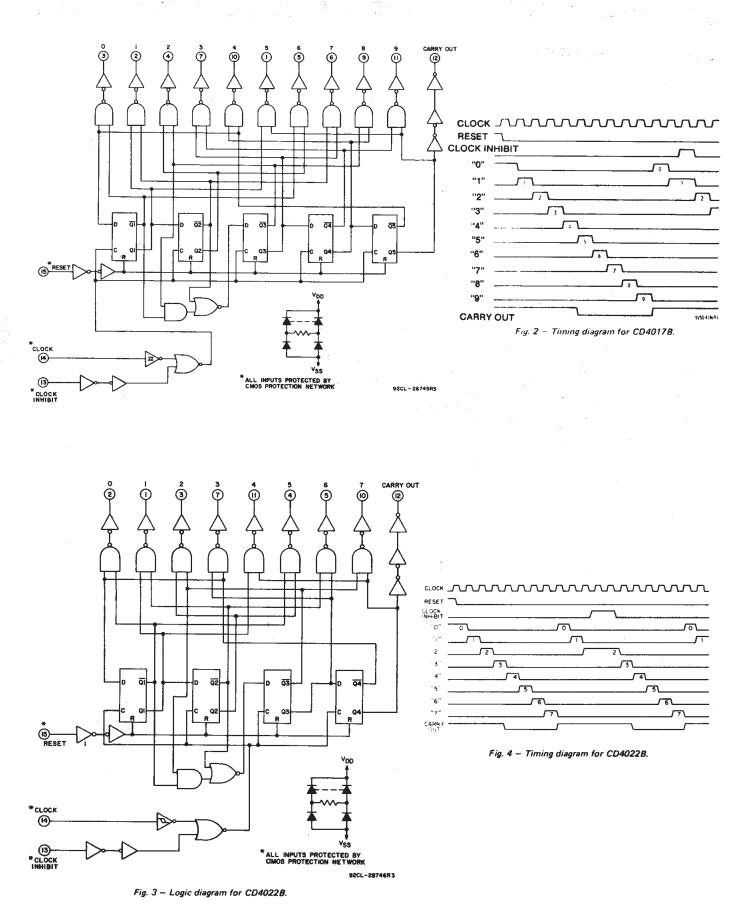




92C5-24464AI

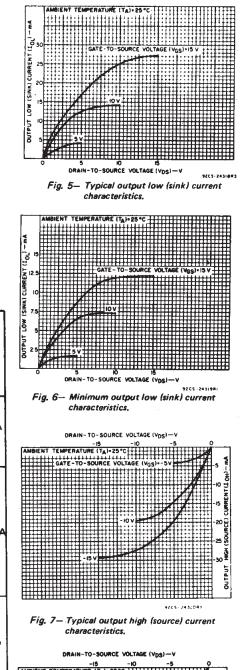
TOP VIEW NC - no connection CD4022B TERMINAL DIAGRAM

*Only if Pin 14 is used as the clock input. If Pin 13 is used as the clock input and Pin 14 is tied high (for advancing count on negative transition of the clock), rise and fall time should be \leq 15 μ s.



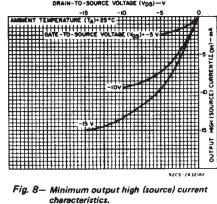
3-52

MAXIMUM RATINGS, Absolute-Maximum Values:	
DC SUPPLY-VOLTAGE RANGE, (VDD)	
Voltages referenced to V _{SS} Terminal)	0.5V to +20V
INPUT VOLTAGE RANGE, ALL INPUTS	0.5V to V _{DD} +0.5V
DC INPUT CURRENT, ANY ONE INPUT	±10mA
POWER DISSIPATION PER PACKAGE (PD):	
For T _A = -55°C to +100°C	
For TA = +100°C to +125°C De DEVICE DISSIPATION PER OUTPUT TRANSISTOR	
For T _A = +100°C to +125°C De	erate Linearity at 12mW/ ⁰ C to 200mW
For $T_A = +100^{\circ}C$ to $+125^{\circ}C$ De DEVICE DISSIPATION PER OUTPUT TRANSISTOR FOR $T_A =$ FULL PACKAGE-TEMPERATURE RANGE (All Package Ty OPERATING-TEMPERATURE RANGE (T_A)	prate Linearity at 12mW/°C to 200mW (pes)
For $T_A = +100^{\circ}C$ to $+125^{\circ}C$ De DEVICE DISSIPATION PER OUTPUT TRANSISTOR FOR $T_A =$ FULL PACKAGE-TEMPERATURE RANGE (All Package Ty OPERATING-TEMPERATURE RANGE (T_A)	prate Linearity at 12mW/°C to 200mW (pes)
For $T_A = +100^{\circ}C$ to $+125^{\circ}C$ De DEVICE DISSIPATION PER OUTPUT TRANSISTOR FOR $T_A =$ FULL PACKAGE-TEMPERATURE RANGE (All Package Ty	prate Linearity at 12mW/°C to 200mW (pes)



3

COMMERCIAL CMOS HIGH VOLTAGE IC8



STATIC	ELECTRICAL CHARACTERIS	TICS

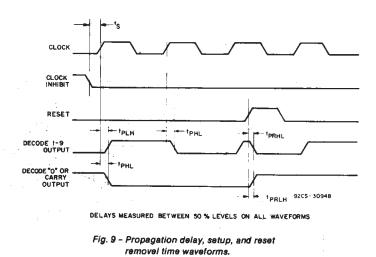
STATIC ELECT	RICAL (CHAR	ACTE	RISTIC	S						υ	
CHARAC- TERISTIC	CON	DITIO	NS	LIMITS AT INDICATED TEMPERATURES (°C)						c)	N I T	
	v _o							+25			s	
	(V)	(V)	V _{DD} (V)	-55	40	+85	+125	Min.	Тур.	Max.		
0	_	0,5	5	5	5	150	150	_	0.04	5		
Quiescent Device	-	0,10	10	10	10	300	300	-	0.04	10	μA	
Current,	-	0,15	15	20	20	600	600	_	0.04	20		
IDD Max.	_	0,20	20	100	100	3000	3000	-	0.08	100		
Output Low	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1	-		
(Sink) Current	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	-		
IOL Min.	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	-		
Queense High	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	-	mA	
Output High (Source) Current, IOH ^{Min.}	2.5	0,5	5	2	-1.8	-1.3	-1.15	-1.6	-3.2			
	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	-		
	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	-		
Output Voltage:		0,5	5	0.05 - 0 0.0						0.05		
Low Level,		0,10	10		0	0.05	-					
VOL Max.	-	0,15	15	0.05 - 0 0.05						0.05	٧	
Output	~	0,5	5		4	.95	-	4.95	5	-		
Voltage: High-Level,		0,10	10	9.95 9.95 10 -								
VOH Min.	-	0,15	15		14	.95		14.95	15	· -		
	0.5,4.5	5,4.5 - 5 1.5				-	-	1.5				
	Input Low 1,9 – 10 3				3		-	-	3]		
VIL Max.	1.5,13.5	-	15	4						4	٧	
Input High	0.5,4.5	-	5	3.5 3.5 -					-			
Voltage,	1,9	-	10	7 7 -					-]		
V _{EH} Min.	1.5,13.5	-	15			11		11	-	-		
Input Current IIN Max.	-	0,18	18	±0.1 ±0.1 ±1 ±1 -					±10 ⁻⁵	±0.1	μA	

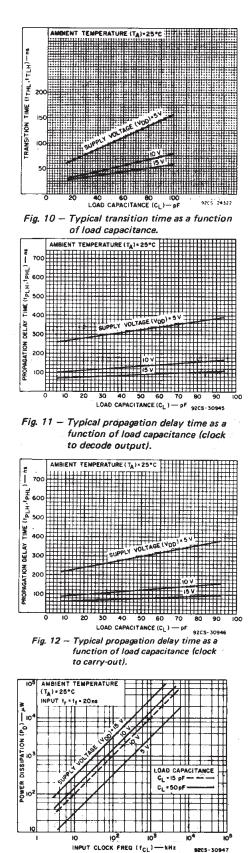
DYNAMIC ELECTRICAL CHARACTERISTICS

At T_A = 25°C, Input t_r, t_f = 20 ns, C_L = 50 pF, R_L = 200 k Ω

CHARACTERISTIC	CONDITIONS		UNITS		
-	V _{DD} (V)			Max.	
CLOCKED OPERATION			-	.	
	5	_	325	650	
Propagation Delay Time, tpHL, tpLH	10	-	135	270	
Decode Out	15	-	85	170	ns
	5	_	300	600	
Carry Out	10		125	250	
· · · · · · · · · · · · · · · · · · ·	15	_	80	160	
Transition Time, tTHL, tTLH	5	_	100	200	
Carry Out or Decode Out Line	10	-	50	100	ns
	15	-	40	80	
	5	2.5	5	-	
Maximum Clock Input Frequency, fCL*	10	5	10	_	MHz
	15	5.5	11	-	
	5	_	100	200	
Minimum Clock Pulse Width, tw	10	_	45	90	ns
-	15	-	30	60	
Clock Rise or Fall Time, t _r CL, t _f CL	5, 10, 15	UNLIMITED			
Minimum Clock Inhibit	5		115	230	
to Clock Setup Time, t _s	10	_	50	100	ns
	15	-	35	70	
Input Capacitance, CIN	Any Input	1	5	_	pF
RESET OPERATION	· · ·			÷	
Propagation Delay Time, tPHL, tPLH	5	_	265	530	
Carry Out or Decode Out Lines	10	_	115	230	ns
	15	-	85 [.]	170	
	5	_	130	260	
Minimum Reset Pulse Width, t _W	10	-	55	110	ns
	15	_	30	60	
	5		200	400	
Minimum Reset Removal Time	10	_		280	ns
	15	_	75	150	

* Measured with respect to carry output line.





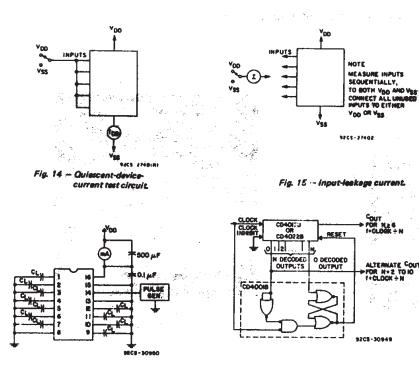
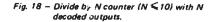


Fig. 17 - Dynamic power dissipation test circuit.



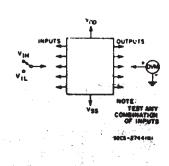


Fig. 16 - Input-voltage test circuit.

When the Nth decoded output is reached (Nth clock pulse) the S-R flip flop (constructed from two NOR gates of the CD4001B) generates a reset pulse which clears the CD4017B or CD4022B to its zero count. At this time, if the Nth dacoded output is greater than or equal to 6 in the CD-4017B or 5 in the CD4022B, the COUT line goes high to clock the next CD4017B or CD-4022B counter section. The "0" decoded output also goes high at this time. Coincidence of the clock low and decoded "0" output low resets the S-R flip flop to enable the CD4017B or CD4022B. If the Nth decoded output is less than 6 (CD4017B) or 5 (CD4022B), the COUT line will not go high and, therefore, cannot be used. in this case "0" decoded output may be used to perform the clocking function for the next counter.



3

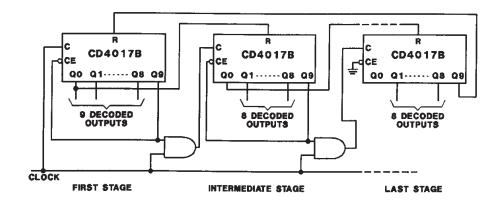
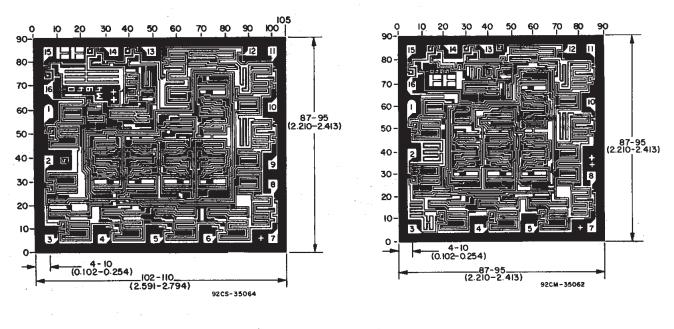


Fig. 19 - Cascading the CD4017B.

CHIP DIMENSIONS AND PAD LAYOUTS



CD4017BH

in Tae

CD4022BH

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils $(10^{-3}$ inch).

TEXAS INSTRUMENTS

27-May-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finisl	n MSL Peak Temp ⁽³⁾
89270AKB3T	OBSOLETE			0		TBD	Call TI	Call TI
CD4017BE	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4017BF	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
CD4017BF3A	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
CD4017BM	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
CD4017BM96	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
CD4017BM96E4	ACTIVE	SOIC	D	16	2500	TBD	Call TI	Call TI
CD4017BME4	ACTIVE	SOIC	D	16	40	TBD	Call TI	Call TI
CD4017BNSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
CD4017BNSRE4	ACTIVE	SO	NS	16	2000	TBD	Call TI	Call TI
CD4017BPW	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4017BPWE4	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4017BPWR	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4017BPWRE4	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4022BE	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4022BF	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
CD4022BF3A	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
CD4022BNSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
CD4022BNSRE4	ACTIVE	SO	NS	16	2000	TBD	Call TI	Call TI
CD4022BPW	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4022BPWE4	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4022BPWR	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4022BPWRE4	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
JM38510/05651BEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



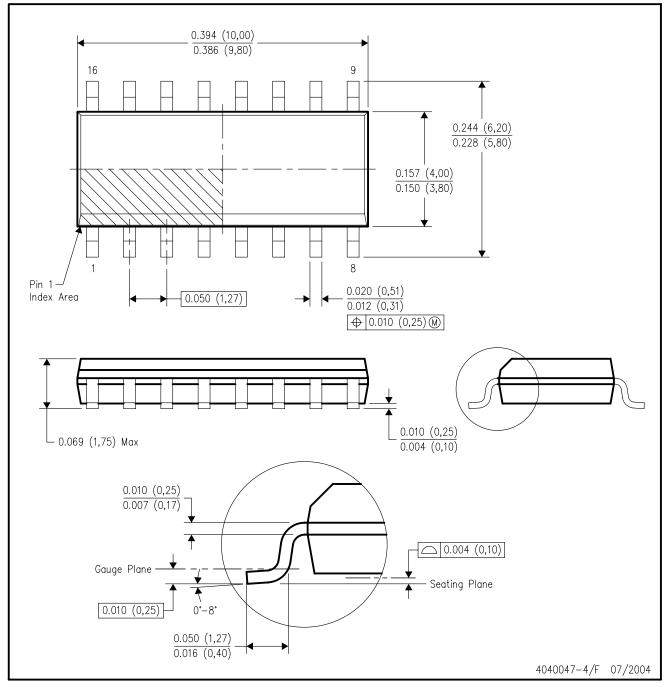
NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AC.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



MECHANICAL DATA

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address:

Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

Copyright © 2005, Texas Instruments Incorporated